TOSHIBA

TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRIAC

TLP3061(S),TLP3062(S),TLP3063(S)

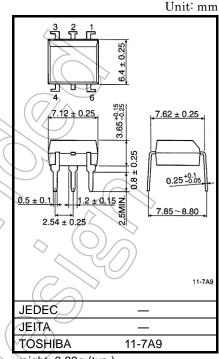
OFFICE MACHINE HOUSEHOLD USE EQUIPMENT TRIAC DRIVER SOLID STATE RELAY

The TOSHIBA TLP3061 (S), TLP3062 (S), TLP3063 (S) consist of a zero voltage crossing turn-on photo-triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package.

- Peak Off-State Voltage : 600 V (min)
- Trigger LED Current
- : 15 mA (max) (TLP3061(S))
 10 mA (max) (TLP3062(S))
 5 mA (max) (TLP3063(S))
 : 100 mA (max)
- On-State Current
- Isolation Voltage : 5000 Vrms (min)
- UL approved: UL1577, File No.E67349
- cUL approved CSA Component Acceptance Service No. 5A, File No.E67349
- CQC approved: GB4943.1,GB8898 Japan Factory Option (D4) VDE approved : DIN EN60747-5-5 ,EN60065,EN60950-1 (Note1) EN62368-1(Pending) (Note1)

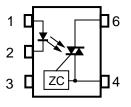
(Note 1):When a VDE approved type is needed, please designate the "Option (D4)"

•	Construction mech	anical rating	
		7.62 mm pitch Standard Type	10.16 mm pitch TLPxxxxF type
	Creepage Distance Clearance Insulation Thickness	7.0 mm (Min) 7.0 mm (Min) 0.5 mm (Min)	8.0 mm (Min) 8.0 mm (Min) 0.5 mm (Min)



weight: 0.39g (typ.)

Pin Configuration (top view)



1: Anode 2: Cathode 3: N.C. 4:Terminal 1 6:Terminal 2

ZC:Zero-cross Circuit

Start of commercial production 1996-09

Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit	
	Forward current		lF	50	mA	
LED	Forward current derating (Ta ≥ 53°C)		ΔI _F / °C	-0.7	mA / °C	
	Peak forward current (100 μs pulse, 100 pps)		IFP	1	A	
	Power dissipation		PD	100	mW	
	Power dissipation derating (Ta ≥ 53°C)		ΔP _D / °C	-1.4	mW / °C	
	Reverse voltage		VR	5	V	
	Junction temperature		Тj	125	(°C/	\sim
	Off-state output terminal voltage		Vdrm	600		\mathcal{O}
	On-state RMS current	Ta = 25°C Ta = 70°C	IT(RMS)	100 50	mA	
	On-state current derating (Ta $\ge 25^{\circ}$ C) Peak on-state current (100µs pulse, 120 pps) Peak nonrepetitive surge current (P _w = 10 ms) Power dissipation		ΔI _T / °C	-1.1	mA/°C	
Detector			ITP	2	A	
ă			ITSM	(1.2)	A	\bigcirc
			PD	300	mW <	
	Power dissipation derating (Ta ≥ 25°C)		ΔP _D /°C	-4.0	mW/°C	
	Junction temperature		$\Omega_{1}($	115	0,	\mathbf{D}
Storage temperature range			Tstg	-55 to 150	ů, Č	I I
Operating temperature range			Topr	-40 to 100	(/°C	
Lead soldering temperature (10 s)			Tsol	260	°e	
Total package power dissipation			PT	330	mW	
Total package power dissipation derating $(Ta \ge 25^{\circ}C)$		ΔP _T / °C	-4.4	mW / °C		
Isolation voltage (AC, 1 min., R.H.≤ 60%) (Note 1)		BVs	5000	Vrms		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Recommended Operating Conditions

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	VAC	_	_	240	Vac
Forward current	lF*	15	20	25	mA
Peak on-state current	I _{TP}	_	_	1	А
Operating temperature	Topr	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

* In the case of TLP3062

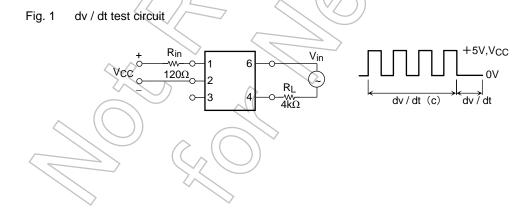
⁽Note 1) Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4 and 6 shorted together.

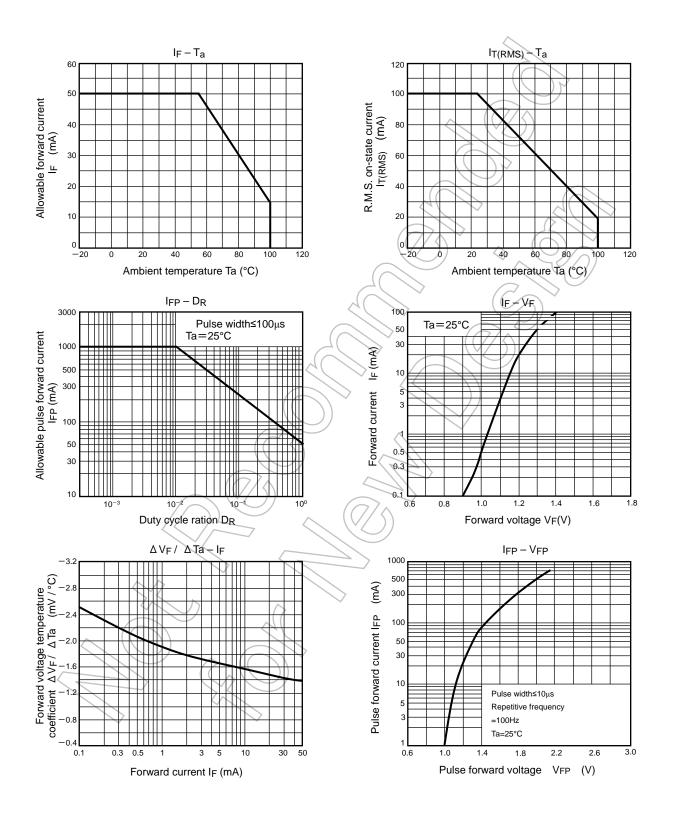
Individual Electrical Characteristics (Ta = 25°C)

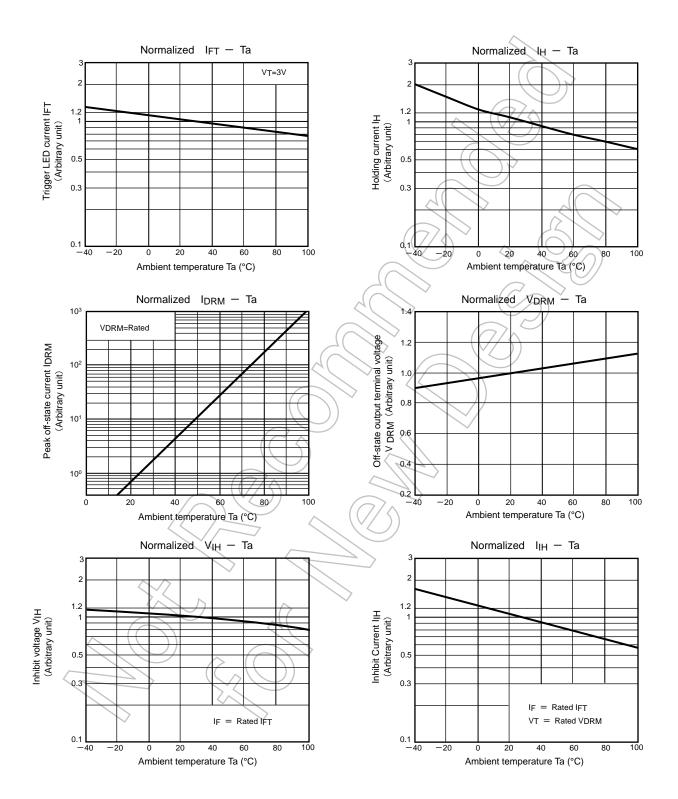
	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance	CT	V = 0 V, f = 1 MHz	X	10	_	pF
	Peak off-state current	IDRM	V _{DRM} = 600 V		10	1000	nA
	Peak on-state voltage	VTM	I _{TM} = 100 mA	K) 1.7	3.0	V
tor	Holding current	Iн	6		0.6	_	mA
Detector	Critical rate of rise of off-state voltage	dv / dt	V _{in} = 240 Vrms, Ta = 85°C (Fig.1)	200	500		V / μs
	Critical rate of rise of commutating voltage	dv / dt (c)	V _{in} = 60 Vrms, I _T = 15mA (Fig.1)	>	0.2		V / μs

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min.	Тур.	Max.	Unit
	TLP3061(S)			\sim	Z	15	
Trigger LED current	TLP3062(S)	IFT	$V_T = 6 V$	$\mathcal{O}_{\mathcal{A}}$	5	10	mA
	TLP3063(S)				_	5	
Inhibit voltage		Viн	IF = rated IFT	–	_	50	V
Leakage in inhibited state		Ін	IF = rated IFT VT = rated VDRM	- -	100	300	μΑ
Capacitance input to output		Cs	Vs = 0 V, f = 1 MHz	—	0.8	_	pF
Isolation resistance		Rs	V _S = 500 V (R.H.≤ 60%)	5×10 ¹⁰	10 ¹⁴	_	Ω
	($\overline{7}$	AC, 1 minute	5000	—	_	Vrms
Isolation voltage		BVs	AC, 1 second, in oil	_	10000	_	vins
	$\overline{\alpha}$		DC, 1 minute, in oil	_	10000	_	V _{dc}







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